



LINEAGE POWER®

QBVW025A0B Series Power Modules; DC-DC Converters

36-75V_{dc} Input; 12V_{dc} Output; 25A Output Current

BARRACUDA SERIES™ Features



RoHS Compliant

Applications

- Distributed power architectures
- Intermediate bus voltage applications
- Servers and storage applications
- Networking equipment including Power over Ethernet (PoE)
- Fan assemblies and other systems requiring a tightly regulated output voltage

Options

- Negative Remote On/Off logic (1=option code, factory preferred)
- Auto-restart after fault shutdown (4=option code, factory preferred)
- Remote Sense and Output Voltage Trim (9=option code)
- Base plate option (-H=option code)
- Passive Droop Load Sharing (-P=option code)

Description

The QBVW025A0B series of dc-dc converters are a new generation of fully regulated DC/DC power modules designed to support 12Vdc intermediate bus applications where multiple low voltages are subsequently generated using point of load (POL) converters, as well as other application requiring a tightly regulated output voltage. The QBVW025A0B series operate from an input voltage range of 36 to 75Vdc and provide up to 25A output current at output voltages of 12V_{dc} in an industry standard, DOSA compliant quarter brick. The converter incorporates digital control, synchronous rectification technology, a fully regulated control topology, and innovative packaging techniques to achieve efficiency exceeding 96% at 12V output. This leads to lower power dissipations such that for many applications a heat sink is not required. Standard features include on/off control, output overcurrent and over voltage protection, over temperature protection, input under and over voltage lockout.

The output is fully isolated from the input, allowing versatile polarity configurations and grounding connections. Built-in filtering for both input and output minimizes the need for external filtering.

- Compliant to RoHS EU Directive 2002/95/EC (-Z versions)
- High and flat efficiency profile – >95.5% at 12V_{dc}, 40% load to 100% output
- Wide Input voltage range: 36-75V_{dc}
- Delivers up to 25A_{dc} output current
- Fully very tightly regulated output voltage
- Low output ripple and noise
- Industry standard, DOSA Compliant Quarter brick: 58.4 mm x 36.8 mm x 11.7 mm (2.30 in x 1.45 in x 0.46 in)
- Constant switching frequency
- Positive Remote On/Off logic
- Output over current/voltage protection
- Over temperature protection
- Wide operating temperature range (-40°C to 85°C)
- UL* 60950-1, 2nd Ed. Recognized, CSA† C22.2 No. 60950-1-07 Certified, and VDE‡ (EN60950-1, 2nd Ed.) Licensed
- CE mark to 2006/96/EC directive§
- Meets the voltage and current requirements for ETSI 300-132-2 and complies with and licensed for Basic insulation rating per EN60950-1
- 2250 Vdc Isolation tested in compliance with IEEE 802.3[¶] PoE standards
- ISO** 9001 and ISO14001 certified manufacturing facilities

* UL is a registered trademark of Underwriters Laboratories, Inc.

† CSA is a registered trademark of Canadian Standards Association.

‡ VDE is a trademark of Verband Deutscher Elektrotechniker e.V.

§ This product is intended for integration into end-user equipment. All of the required procedures of end-use equipment should be followed.

¶ IEEE and 802 are registered trademarks of the Institute of Electrical and Electronics Engineers, Incorporated.

** ISO is a registered trademark of the International Organization of Standards.

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the Data Sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.

Parameter	Device	Symbol	Min	Max	Unit
Input Voltage*					
Continuous		V _{IN}	-0.3	75	V _{dc}
Operating transient ≤ 100mS				100	V _{dc}
Non- operating continuous		V _{IN}	80	100	V _{dc}
Operating Ambient Temperature (See Thermal Considerations section)	All	T _A	-40	85	°C
Storage Temperature	All	T _{stg}	-55	125	°C
I/O Isolation Voltage (100% factory Hi-Pot tested)	All	—	—	2250	V _{dc}

* Input over voltage protection will shutdown the output voltage when the input voltage exceeds threshold level.

Electrical Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions.

Parameter	Device	Symbol	Min	Typ	Max	Unit
Operating Input Voltage		V _{IN}	36	48	75	V _{dc}
Maximum Input Current (V _{IN} =0V to 75V, I _O =I _{O, max})		I _{IN, max}	-	-	9	A _{dc}
Input No Load Current (V _{IN} = V _{IN, nom} , I _O = 0, module enabled)	All	I _{IN, No load}		80		mA
Input Stand-by Current (V _{IN} = V _{IN, nom} , module disabled)	All	I _{IN, stand-by}			22	mA
External Input Capacitance	All		100	-	-	μF
Inrush Transient	All	I ² t	-	-	1	A ² s
Input Reflected Ripple Current, peak-to-peak (5Hz to 20MHz, 12μH source impedance; V _{IN} = 48V, I _O = I _{Omax} ; see Figure 11)	All		-	40	-	mA _{p-p}
Input Ripple Rejection (120Hz)	All		-	25	-	dB

CAUTION: This power module is not internally fused. An input line fuse must always be used.

This power module can be used in a wide variety of applications, ranging from simple standalone operation to an integrated part of sophisticated power architecture. To preserve maximum flexibility, internal fusing is not included, however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a fast-acting fuse with a maximum rating of 30 A in the ungrounded input lead of the power supply (see Safety Considerations section). Based on the information provided in this Data Sheet on inrush energy and maximum dc input current, the same type of fuse with a lower rating can be used. Refer to the fuse manufacturer's Data Sheet for further information.

Electrical Specifications (continued)

Parameter	Device	Symbol	Min	Typ	Max	Unit
Output Voltage Set-point (V _{IN} =V _{IN,nom} , I _O =12.5A, T _A =25°C)	All	V _{O, set}	11.97	12.00	12.03	V _{dc}
Output Voltage (Over all operating input voltage (40V to 75V), resistive load, and temperature conditions until end of life)	All w/o -P -P Option	V _O V _O	11.76 11.68	— —	12.24 12.32	V _{dc} V _{dc}
Output Voltage (V _{IN} =36V, T _A = 25°C)	All	V _O	11.15	—	—	V _{dc}
Output Regulation[V _{IN, min} = 40V] Line (V _{IN} = V _{IN, min} to V _{IN, max}) Load (I _O =I _{O, min} to I _{O, max}) Load (I _O =I _{O, min} to I _{O, max}), Intentional Droop Temperature (T _A = -40°C to +85°C)	All All w/o -P -P Option All	 	 	 0.40 	 2	 % V _{O, set} % V _{O, set} V _{dc} % V _{O, set}
Output Ripple and Noise on nominal output (V _{IN} =V _{IN, nom} and I _O =I _{O, min} to I _{O, max}) RMS (5Hz to 20MHz bandwidth) Peak-to-Peak (5Hz to 20MHz bandwidth)	All All	 	 	 70 200	 	 mV _{rms} mV _{pk-pk}
External Output Capacitance For C _O >5000μF, I _O must be < 50% I _{O, max} during T _{rise} .	All	C _{O, max}	0	—	10,000	μF
Output Current	All	I _O	0		25	A _{dc}
Output Current Limit Inception	All	I _{O, lim}	—	30	—	A _{dc}
Efficiency V _{IN} =V _{IN, nom} , T _A =25°C I _O =100% I _{O, max} , V _O = V _{O, set} I _O =40% I _{O, max} to 100% I _{O, max} , V _O = V _{O, set}	All All	 η η	 	 96.0 95.5	 	 % %
Switching Frequency		f _{sw}		150		kHz
Dynamic Load Response dI _O /dI _t =1A/10μs; V _{IN} =V _{IN,nom} ; T _A =25°C; (Tested with a 1.0μF ceramic, a 10μF tantalum, and 470μF capacitor and across the load.) Load Change from I _O = 50% to 75% of I _{O, max} : Peak Deviation Settling Time (V _O <10% peak deviation) Load Change from I _O = 75% to 50% of I _{O, max} : Peak Deviation Settling Time (V _O <10% peak deviation)	All	 V _{pk} t _s V _{pk} t _s	 	 300 700 300 700	 	 mV _{pk} μs mV _{pk} μs

Isolation Specifications

Parameter	Symbol	Min	Typ	Max	Unit
Isolation Capacitance	C _{iso}	—	1000	—	pF
Isolation Resistance	R _{iso}	10	—	—	MΩ

General Specifications

Parameter	Device	Typ	Unit
Calculated Reliability Based upon Telcordia SR-332 Issue 2: Method I, Case 1, (I _O =80%I _{O, max} , T _A =40°C, Airflow = 200 lfm), 90% confidence	MTBF	3,598,391	Hours
	FIT	277.9	10 ⁹ /Hours
Weight – Open Frame		47.4 (1.67)	g (oz.)
Weight – with Base plate option		66.4 (2.34)	g (oz.)

Feature Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions. See Feature Descriptions for additional information.

Parameter	Device	Symbol	Min	Typ	Max	Unit
Remote On/Off Signal Interface (V _{IN} =V _{IN,min} to V _{IN,max} , Signal referenced to V _{IN} -terminal) Negative Logic: device code suffix "1" Logic Low = module On, Logic High = module Off Positive Logic: No device code suffix required Logic Low = module Off, Logic High = module On Logic Low Specification On/Off Thresholds:						
Remote On/Off Current – Logic Low (V _{IN} = 100V)	All	I _{on/off}	280	—	310	μA
Logic Low Voltage	All	V _{on/off}	-0.3	—	0.8	V _{dc}
Logic High Voltage – (Typ = Open Collector)	All	V _{on/off}	2.0	—	14.5	V _{dc}
Logic High maximum allowable leakage current (V _{on/off} = 2.0V)	All	I _{on/off}	—	—	10	μA
Maximum voltage allowed on On/Off pin	All	V _{on/off}	—	—	14.5	V _{dc}
Turn-On Delay and Rise Times (I _O =I _{O,max}) T _{delay} =Time until V _O = 10% of V _{O,set} from either application of V _{IN} with Remote On/Off set to On (Enable with V _{IN}); or operation of Remote On/Off from Off to On with V _{IN} already applied for at least 150 milliseconds (Enable with on/off). * Increased T _{delay} due to startup for parallel modules.						
	All w/o "P" option	T _{delay, Enable with V_{IN}}	—	—	150	ms
	All w/o "P" option	T _{delay, Enable with on/off}	—	—	10	ms
	All w/ "P" option	T _{delay, Enable with V_{IN}}	—	—	180*	ms
	All w/ "P" option	T _{delay, Enable with on/off}	—	—	40*	ms
T _{rise} =Time for V _O to rise from 10% to 90% of V _{O,set} . For C _O >5000μF, I _O must be < 50% I _{O,max} during T _{rise} . * Increased T _{rise} when pre-bias V _O exists at startup for parallel modules.	All w/o "P" option	T _{rise}	—	—	15	ms
	All w/ "P" option	T _{rise}	—	—	300*	ms
Load Sharing Current Balance (difference in output current across all modules with outputs in parallel, no load to full load)	-P Option	I _{diff}			3	A
Remote Sense Range	All w/ "9" option	V _{Sense}	—	—	0.5	V _{dc}
Output Voltage Adjustment range	All w/ "9" option	V _{O, set}	8.1		13.2	V _{dc}
Output Overvoltage Protection	All w/o "9" option	V _{O, limit}	14.5		17.0	V _{dc}
	All w/ "9" option	V _{O, limit}	V _{O, set} +2.5V		V _{O, set} +5.0V	V _{dc}
Overtemperature Protection (See Feature Descriptions)	All	T _{ref}	—	140	—	°C
Input Undervoltage Lockout						
Turn-on Threshold (Default)			33	35	36	V _{dc}
Turn-off Threshold (Default)			31	33	34	V _{dc}
Input Overvoltage Lockout						
Turn-off Threshold (Default)			—	86	—	V _{dc}
Turn-on Threshold (Default)			76	79	—	V _{dc}

Characteristic Curves, 12V_{dc} Output

The following figures provide typical characteristics for the QBVW025A0B (12V, 25A) at 25°C. The figures are identical for either positive or negative Remote On/Off logic.

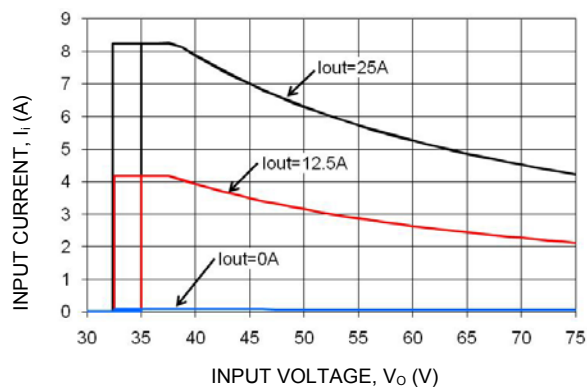


Figure 1. Typical Input Characteristic.

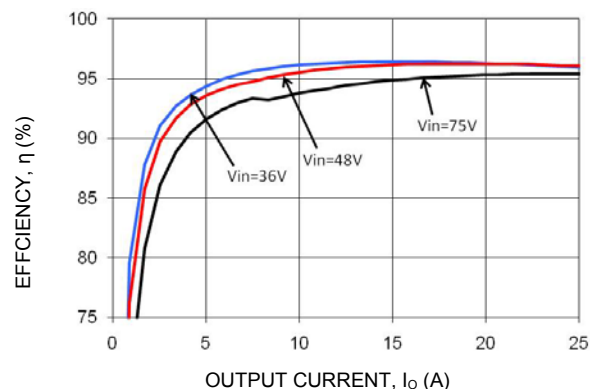


Figure 2. Typical Converter Efficiency Vs. Output Current.

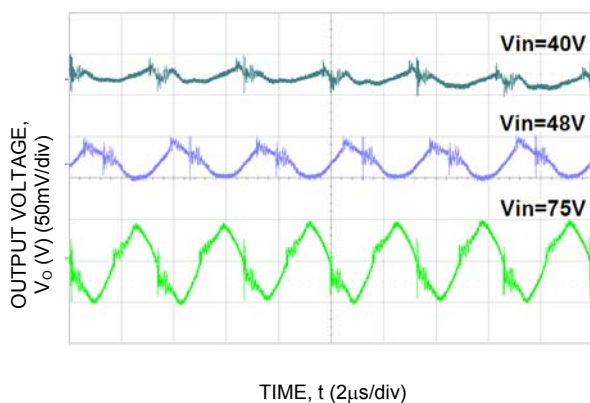


Figure 3. Typical Output Ripple and Noise, $I_o = I_{o,max}$.

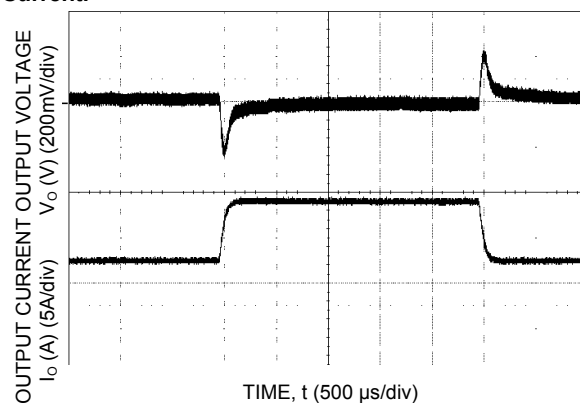


Figure 4. Typical Transient Response to 0.1A/μs Step Change in Load from 50% to 75% to 50% of Full Load, $C_o=470\mu F$ and 48 Vdc Input.

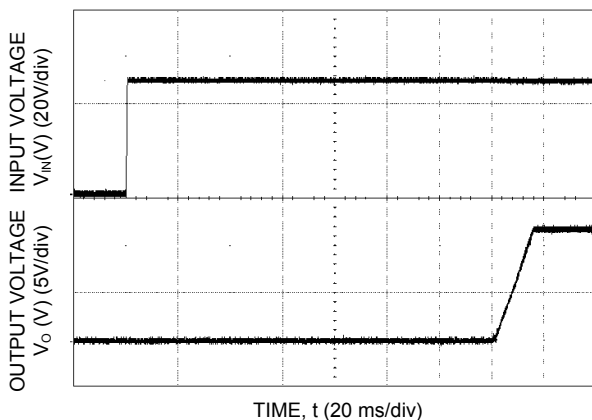


Figure 5. Typical Start-Up Using V_{in} with Remote On/Off enabled, negative logic version shown.

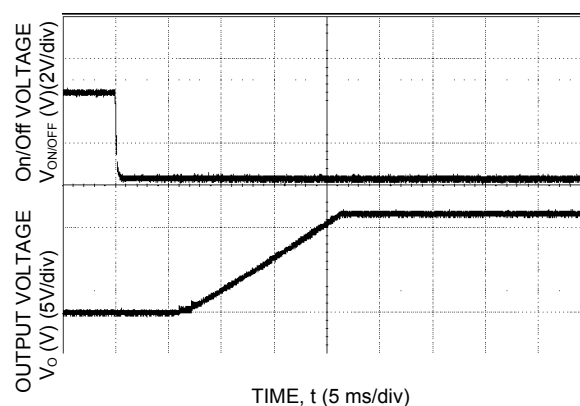


Figure 6. Typical Start-Up Using Remote On/Off with V_{in} applied, negative logic version shown.

Characteristic Curves, 12V_{dc} Output (continued)

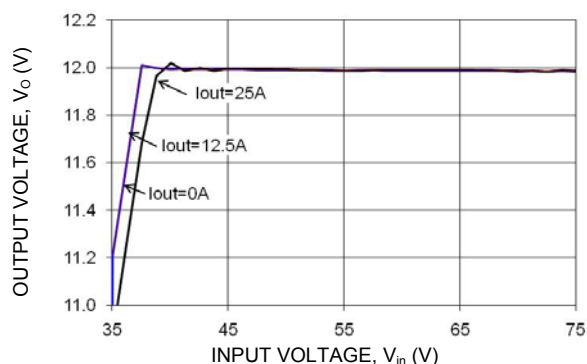


Figure 7. Typical Output Voltage Regulation vs. Input Voltage.

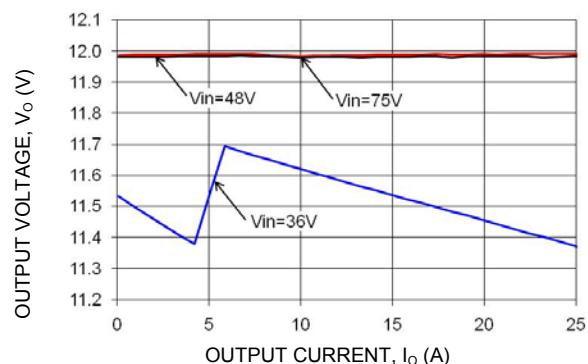


Figure 8. Typical Output Voltage Regulation vs. Output Current .

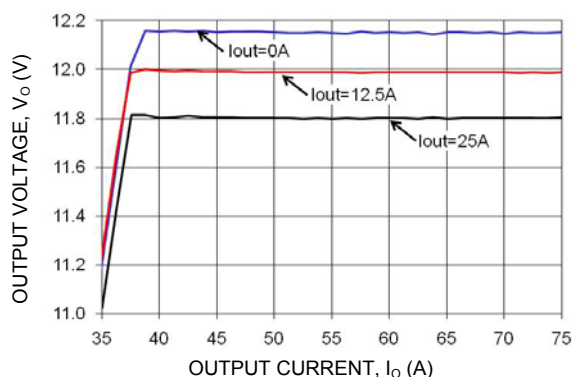


Figure 9. Typical Output Voltage regulation vs. Input Voltage for the -P Option.

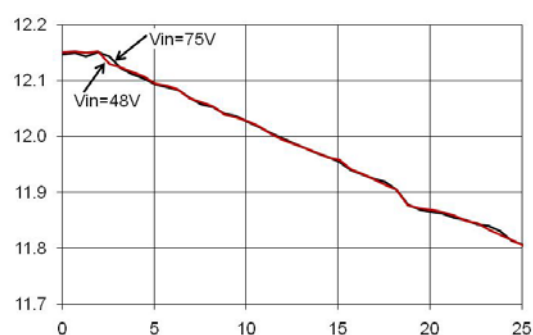
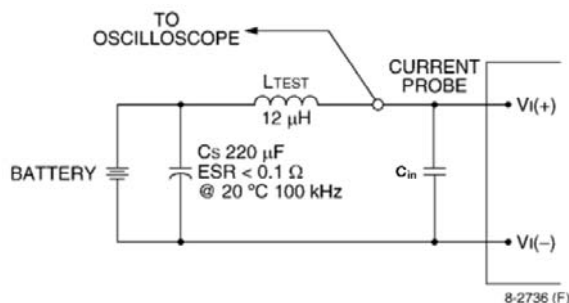


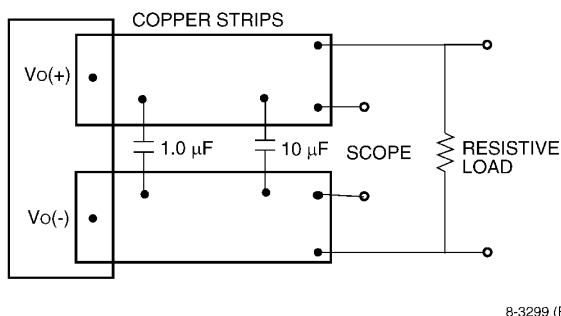
Figure 10. Typical Output Voltage Regulation vs. Output Current for the -P Option.

Test Configurations



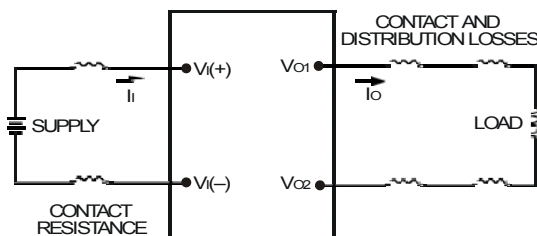
Note: Measure input reflected-ripple current with a simulated source inductance (LTEST) of 12 µH. Capacitor CS offsets possible battery impedance. Measure current as shown above.

Figure 11. Input Reflected Ripple Current Test Setup.



Note: Use a 1.0 µF ceramic capacitor and a 10 µF aluminum or tantalum capacitor. Scope measurement should be made using a BNC socket. Position the load between 51 mm and 76 mm (2 in. and 3 in.) from the module.

Figure 12. Output Ripple and Noise Test Setup.



Note: All measurements are taken at the module terminals. When socketing, place Kelvin connections at module terminals to avoid measurement errors due to socket contact resistance.

$$\eta = \left(\frac{[V_O(+)-V_O(-)]I_O}{[V_I(+)-V_I(-)]I_I} \right) \times 100 \%$$

Figure 13. Output Voltage and Efficiency Test Setup.

Design Considerations

Input Source Impedance

The power module should be connected to a low ac-impedance source. Highly inductive source impedance can affect the stability of the power module. For the test configuration in Figure 11, a 100µF electrolytic capacitor, C_{in}, (ESR<0.7Ω at 100kHz), mounted close to the power module helps ensure the stability of the unit.

Safety Considerations

For safety-agency approval of the system in which the power module is used, the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standard, i.e., UL60950-1 2nd Ed., CSA C22.2 No. 60950-1 2nd Ed., and VDE0805-1 EN60950-1 2nd Ed.

If the input source is non-SELV (ELV or a hazardous voltage greater than 60 Vdc and less than or equal to 75Vdc), for the module's output to be considered as meeting the requirements for safety extra-low voltage (SELV), all of the following must be true:

- The input source is to be provided with reinforced insulation from any other hazardous voltages, including the ac mains.
- One V_{IN} pin and one V_{OUT} pin are to be grounded, or both the input and output pins are to be kept floating.
- The input pins of the module are not operator accessible.
- Another SELV reliability test is conducted on the whole system (combination of supply source and subject module), as required by the safety agencies, to verify that under a single fault, hazardous voltages do not appear at the module's output.

Note: Do not ground either of the input pins of the module without grounding one of the output pins. This may allow a non-SELV voltage to appear between the output pins and ground.

The power module has safety extra-low voltage (SELV) outputs when all inputs are SELV.

The input to these units is to be provided with a maximum 30 A fast-acting (or time-delay) fuse in the ungrounded input lead.

Feature Descriptions

Overcurrent Protection

To provide protection in a fault output overload condition, the module is equipped with internal current-limiting circuitry and can endure current limiting continuously. If the overcurrent condition causes the output voltage to fall greater than 4.0V from $V_{o, set}$, the module will shut down and remain latched off. The overcurrent latch is reset by either cycling the input power or by toggling the on/off pin for one second. If the output overload condition still exists when the module restarts, it will shut down again. This operation will continue indefinitely until the overcurrent condition is corrected.

A factory configured auto-restart option (with overcurrent and overvoltage auto-restart managed as a group) is also available. An auto-restart feature continually attempts to restore the operation until fault condition is cleared.

Remote On/Off

The module contains a standard on/off control circuit reference to the $V_{IN(-)}$ terminal. Two factory configured remote on/off logic options are available. Positive logic remote on/off turns the module on during a logic-high voltage on the ON/OFF pin, and off during a logic low. Negative logic remote on/off turns the module off during a logic high, and on during a logic low. Negative logic, device code suffix "1," is the factory-preferred configuration. The On/Off circuit is powered from an internal bias supply, derived from the input voltage terminals. To turn the power module on and off, the user must supply a switch to control the voltage between the On/Off terminal and the $V_{IN(-)}$ terminal ($V_{on/off}$). The switch can be an open collector or equivalent (see Figure 14). A logic low is $V_{on/off} = -0.3V$ to 0.8V. The typical $I_{on/off}$ during a logic low ($V_{in}=48V$, On/Off Terminal=0.3V) is 147 μA . The switch should maintain a logic-low voltage while sinking 310 μA . During a logic high, the maximum $V_{on/off}$ generated by the power module is 8.2V. The maximum allowable leakage current of the switch at $V_{on/off} = 2.0V$ is TBD μA . If using an external voltage source, the maximum voltage $V_{on/off}$ on the pin is 14.5V with respect to the $V_{IN(-)}$ terminal.

If not using the remote on/off feature, perform one of the following to turn the unit on:

For negative logic, short ON/OFF pin to $V_{IN(-)}$.

For positive logic: leave ON/OFF pin open.

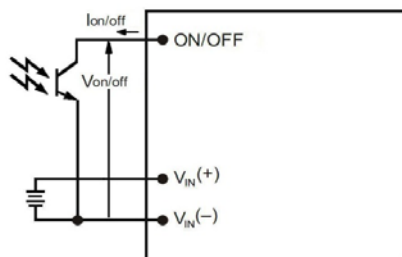


Figure 14. Remote On/Off Implementation.

Output Overvoltage Protection

The module contains circuitry to detect and respond to output overvoltage conditions. If the overvoltage condition

causes the output voltage to rise above the limit in the Specifications Table, the module will shut down and remain latched off. The overvoltage latch is reset by either cycling the input power, or by toggling the on/off pin for one second. If the output overvoltage condition still exists when the module restarts, it will shut down again. This operation will continue indefinitely until the overvoltage condition is corrected.

A factory configured auto-restart option (with overcurrent and overvoltage auto-restart managed as a group) is also available. An auto-restart feature continually attempts to restore the operation until fault condition is cleared.

Overtemperature Protection

These modules feature an overtemperature protection circuit to safeguard against thermal damage. The circuit shuts down the module when the maximum device reference temperature is exceeded. The module will automatically restart once the reference temperature cools by ~25°C.

Input Under/Over voltage Lockout

At input voltages above or below the input under/over voltage lockout limits, module operation is disabled. The module will begin to operate when the input voltage level changes to within the under and overvoltage lockout limits.

Load Sharing

For higher power requirements, the QBVW025A0 power module offers an optional feature for parallel operation (-P Option code). This feature provides a precise forced output voltage load regulation droop characteristic. The output set point and droop slope are factory calibrated to insure optimum matching of multiple modules' load regulation characteristics. To implement load sharing, the following requirements should be followed:

- The $V_{OUT}(+)$ and $V_{OUT}(-)$ pins of all parallel modules must be connected together. Balance the trace resistance for each module's path to the output power planes, to insure best load sharing and operating temperature balance.
- V_{IN} must remain between 40V_{dc} and 75V_{dc} for droop sharing to be functional.
- These modules contain means to block reverse current flow upon start-up, when output voltage is present from other parallel modules, thus eliminating the requirement for external output ORing devices. Modules with the -P option will self determine the presence of voltage on the output from other operating modules, and automatically increase its Turn On delay, T_{delay} , as specified in the Feature Specifications Table.
- When parallel modules startup into a pre-biased output, e.g. partially discharged output capacitance, the T_{rise} is automatically increased, as specified in the Feature Specifications Table, to insure graceful startup.
- Insure that the load is <50% $I_{O, MAX}$ (for a single module) until all parallel modules have started (load full start > module T_{delay} time max + T_{rise} time).
- If fault tolerance is desired in parallel applications, output ORing devices should be used to prevent a single module failure from collapsing the load bus.

Feature Descriptions (continued)

Remote Sense (9 Option Code)

Remote sense minimizes the effects of distribution losses by regulating the voltage at the remote-sense connections (See Figure 15). The SENSE(-) pin should be always connected to V_O(-). The voltage between the remote-sense pins and the output terminals must not exceed the output voltage sense range given in the Feature Specifications table:

$$[V_O(+)-V_O(-)]-[SENSE(+)] \leq 0.5 \text{ V}$$

Although the output voltage can be increased by both the remote sense and by the trim, the maximum increase for the output voltage is not the sum of both. The maximum increase is the larger of either the remote sense or the trim.

The amount of power delivered by the module is defined as the voltage at the output terminals multiplied by the output current. When using remote sense and trim, the output voltage of the module can be increased, which at the same output current would increase the power output of the module. Care should be taken to ensure that the maximum output power of the module remains at or below the maximum rated power (Maximum rated power = V_{O,set} x I_{O,max}).

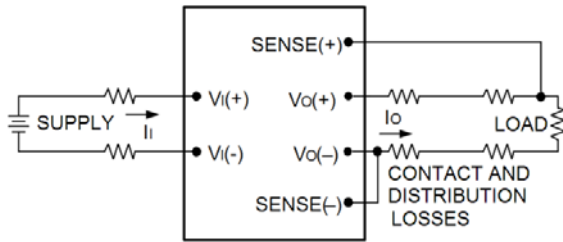


Figure 15. Circuit Configuration for remote sense.

Trim, Output Voltage Adjust (9 Option Code)

Trimming allows the output voltage set point to be increased or decreased; this is accomplished by connecting an external resistor between the TRIM pin and either the V_O(+) pin or the V_O(-) pin.

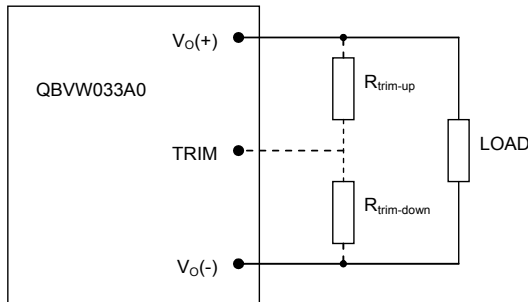


Figure 16. Circuit Configuration to Trim Output Voltage.

Connecting an external resistor (R_{trim-down}) between the TRIM pin and the V_O(-) (or Sense(-)) pin decreases the output voltage set point. To maintain set point accuracy, the trim resistor tolerance should be ±1.0%.

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The following equation determines the required external resistor value to obtain a percentage output voltage change of Δ%

$$R_{trim-down} = \left[\frac{511}{\Delta\%} - 10.22 \right] \text{ K}\Omega$$

$$\Delta\% = \left(\frac{V_{O,set} - V_{desired}}{V_{O,set}} \right) \times 100$$

Where

For example, to trim-down the output voltage of the 12V nominal module by 20% to 9.6V, R_{trim-down} is calculated as follows:

$$\Delta\% = 20$$

$$R_{trim-down} = \left[\frac{511}{20} - 10.22 \right] \text{ K}\Omega$$

$$R_{trim-down} = 15.3 \text{ k}\Omega$$

Connecting an external resistor (R_{trim-up}) between the TRIM pin and the V_O(+) (or Sense (+)) pin increases the output voltage set point. The following equations determine the required external resistor value to obtain a percentage output voltage change of Δ%:

$$R_{trim-up} = \left[\frac{5.11 \times V_{O,set} \times (100 + \Delta\%)}{1.225 \times \Delta\%} - \frac{511}{\Delta\%} - 10.22 \right] \text{ K}\Omega$$

$$\Delta\% = \left(\frac{V_{desired} - V_{O,set}}{V_{O,set}} \right) \times 100$$

Where

For example, to trim-up the output voltage of the 12V module by 5% to 12.6V, R_{trim-up} is calculated as follows:

$$\Delta\% = 5$$

$$R_{trim-up} = \left[\frac{5.11 \times 12.0 \times (100 + 5)}{1.225 \times 5} - \frac{511}{5} - 10.22 \right] \text{ K}\Omega$$

$$R_{trim-up} = 938.8 \text{ K}\Omega$$

The voltage between the V_O(+) and V_O(-) terminals must not exceed the minimum output overvoltage protection value shown in the Feature Specifications table. This limit includes any increase in voltage due to remote-sense compensation and output voltage set-point adjustment trim.

Although the output voltage can be increased by both the remote sense and by the trim, the maximum increase for the output voltage is not the sum of both. The maximum increase is the larger of either the remote sense or the trim. The amount of power delivered by the module is defined as the voltage at the output terminals multiplied by the output current. When using remote sense and trim, the output voltage of the module can be increased, which at the same output current would increase the power output of the module. Care should be taken to ensure that the maximum output power of the module remains at or below the maximum rated power (Maximum rated power = V_{O,set} x I_{O,max}).

Feature Descriptions (continued)

Thermal Considerations

The power modules operate in a variety of thermal environments and sufficient cooling should be provided to help ensure reliable operation.

Thermal considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability. The thermal data presented here is based on physical measurements taken in a wind tunnel.

Heat-dissipating components are mounted on the top side of the module. Heat is removed by conduction, convection and radiation to the surrounding environment. Proper cooling can be verified by measuring the thermal reference temperature (TH₁ or TH₂). Peak temperature occurs at the position indicated in Figure 17 and 18. For reliable operation this temperature should not exceed TH₁=125°C or TH₂=105°C. For extremely high reliability you can limit this temperature to a lower value.

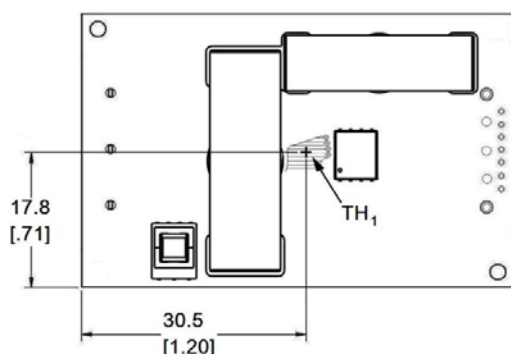


Figure 17. Location of the thermal reference temperature TH₁.

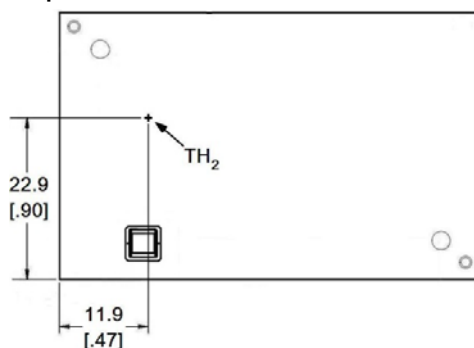


Figure 18. Location of the thermal reference temperature TH₂ for Base plate module.

The output power of the module should not exceed the rated power for the module as listed in the Ordering Information table.

Please refer to the Application Note "Thermal Characterization Process For Open-Frame Board-Mounted Power Modules" for a detailed discussion of thermal aspects including maximum device temperatures.

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Heat Transfer via Convection

Increased airflow over the module enhances the heat transfer via convection. The thermal derating of figure 19-23 shows the maximum output current that can be delivered by each module in the indicated orientation without exceeding the maximum TH_x temperature versus local ambient temperature (T_A) for air flows of, Natural Convection, 1 m/s (200 ft./min), 2 m/s (400 ft./min).

The use of Figure 19 is shown in the following example:

Example

What is the minimum airflow necessary for a QBVW025A0B operating at V_i = 48 V, an output current of 20A, and a maximum ambient temperature of 70 °C in transverse orientation.

Solution:

Given: V_i = 48V, I_O = 20A, T_A = 60 °C

Determine required airflow (V) (Use Figure 19:

V = 0.5m/s (100 LFM) or greater.

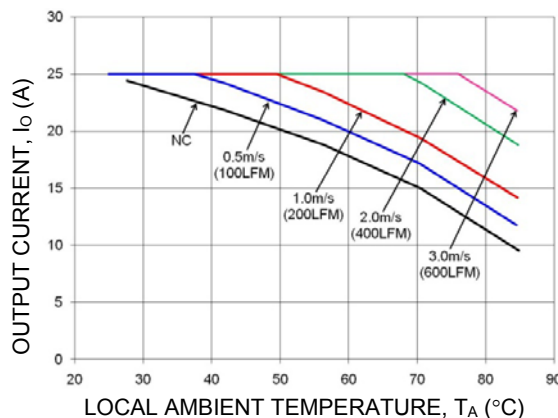


Figure 19. Output Current Derating for the Open Frame QBVW025A0B in the Transverse Orientation; Airflow Direction from Vin(+) to Vin(-); Vin = 48V.

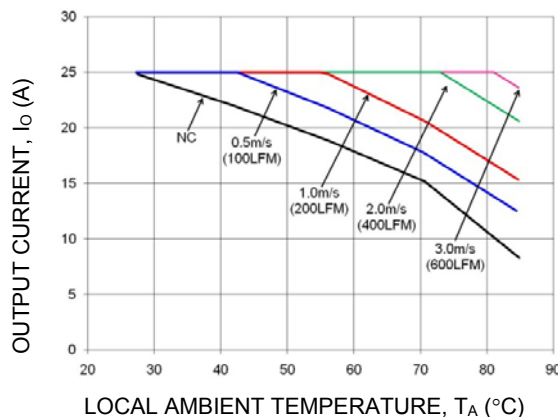


Figure 20. Output Current Derating for the Base plate QBVW025A0B-H in the Transverse Orientation; Airflow Direction from Vin(+) to Vin(-); Vin = 48V.

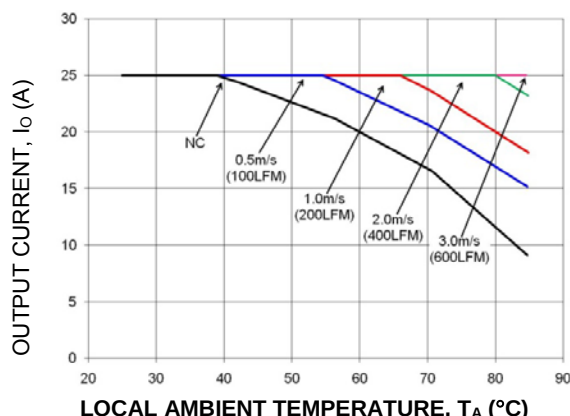


Figure 21. Output Current Derating for the Base plate QBVW025A0B-H with 0.25" heatsink in the Transverse Orientation; Airflow Direction from Vin(+) to Vin(-); Vin = 48V.

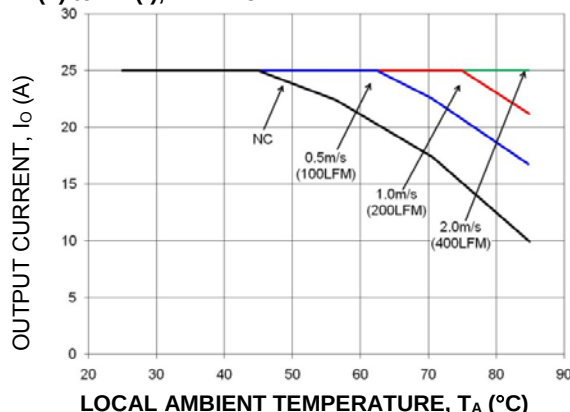


Figure 22. Output Current Derating for the Base plate QBVW025A0B-H with 0.5" heatsink in the Transverse Orientation; Airflow Direction from Vin(+) to Vin(-); Vin = 48V.

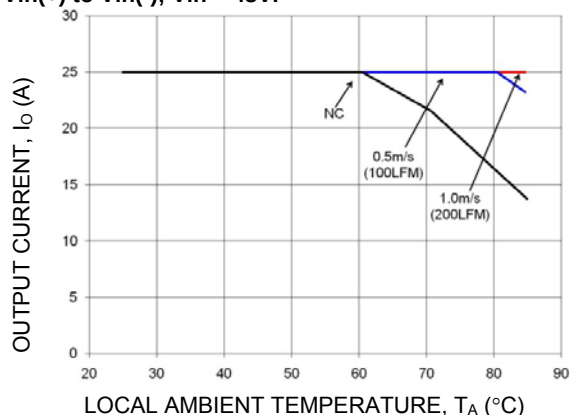


Figure 23. Output Current Derating for the Base plate QBVW025A0B-H with 1.0" heatsink in the Transverse Orientation; Airflow Direction from Vin(+) to Vin(-); Vin = 48V.

Layout Considerations

The QBVW025 power module series are low profile in order to be used in fine pitch system card architectures. As such, component clearance between the bottom of the power module and the mounting board is limited. Avoid placing copper areas on the outer layer directly underneath the power module. Also avoid placing via interconnects underneath the power module.

For additional layout guide-lines, refer to FLTR100V10 Data Sheet.

Through-Hole Lead-Free Soldering Information

The RoHS-compliant, Z version, through-hole products use the SAC (Sn/Ag/Cu) Pb-free solder and RoHS-compliant components. The module is designed to be processed through single or dual wave soldering machines. The pins have a RoHS-compliant, pure tin finish that is compatible with both Pb and Pb-free wave soldering processes. A maximum preheat rate of 3°C/s is suggested. The wave preheat process should be such that the temperature of the power module board is kept below 210°C. For Pb solder, the recommended pot temperature is 260°C, while the Pb-free solder pot is 270°C max.

Reflow Lead-Free Soldering Information

The RoHS-compliant through-hole products can be processed with following paste-through-hole Pb or Pb-free reflow process.

Max. sustain temperature :
245°C (J-STD-020C Table 4-2: Packaging Thickness ≥ 2.5mm / Volume > 2000mm³),
Peak temperature over 245°C is not suggested due to the potential reliability risk of components under continuous high-temperature.
Min. sustain duration above 217°C : 90 seconds
Min. sustain duration above 180°C : 150 seconds
Max. heat up rate: 3°C/sec
Max. cool down rate: 4°C/sec
In compliance with JEDEC J-STD-020C spec for 2 times reflow requirement.

Pb-free Reflow Profile

BMP module will comply with J-STD-020 Rev. C (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. BMP will comply with JEDEC J-STD-020C specification for 3 times reflow requirement. The suggested Pb-free solder paste is Sn/Ag/Cu (SAC). The recommended linear reflow profile using Sn/Ag/Cu solder is shown in Figure 24.

Reflow Lead-Free Soldering Information (continued)

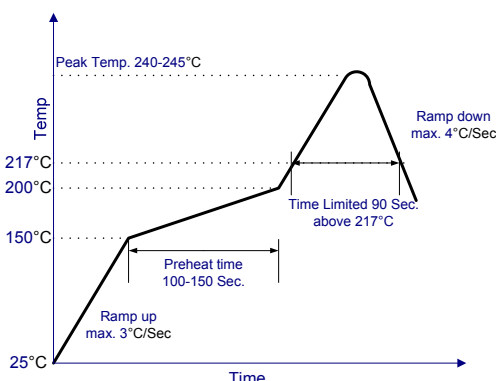


Figure 24. Recommended linear reflow profile using Sn/Ag/Cu solder.

MSL Rating

The QBVW025A0B modules have a MSL rating of 2a.

Storage and Handling

The recommended storage environment and handling procedures for moisture-sensitive surface mount

packages is detailed in J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices). Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of $\leq 30^{\circ}\text{C}$ and 60% relative humidity varies according to the MSL rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions: $< 40^{\circ}\text{C}$, $< 90\%$ relative humidity.

Post Solder Cleaning and Drying Considerations

Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly. For guidance on appropriate soldering, cleaning and drying procedures, refer to Lineage Power Board Mounted Power Modules: Soldering and Cleaning Application Note (AP01-056EPS).

If additional information is needed, please consult with your Lineage Power representative for more details.

EMC Considerations

The circuit and plots in Figure 25 shows a suggested configuration to meet the conducted emission limits of EN55022 Class A. For further information on designing for EMC compliance, please refer to the FLTR100V10 data sheet.

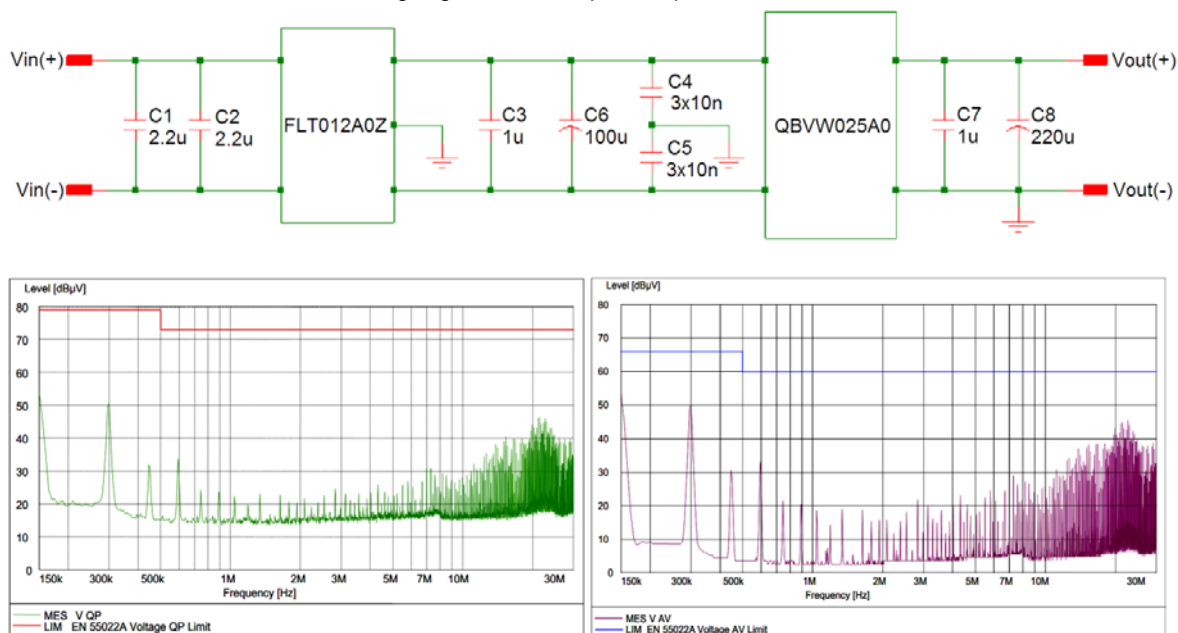


Figure 25. EMC Considerations

Mechanical Outline for QBVW025A0B Through-hole Module

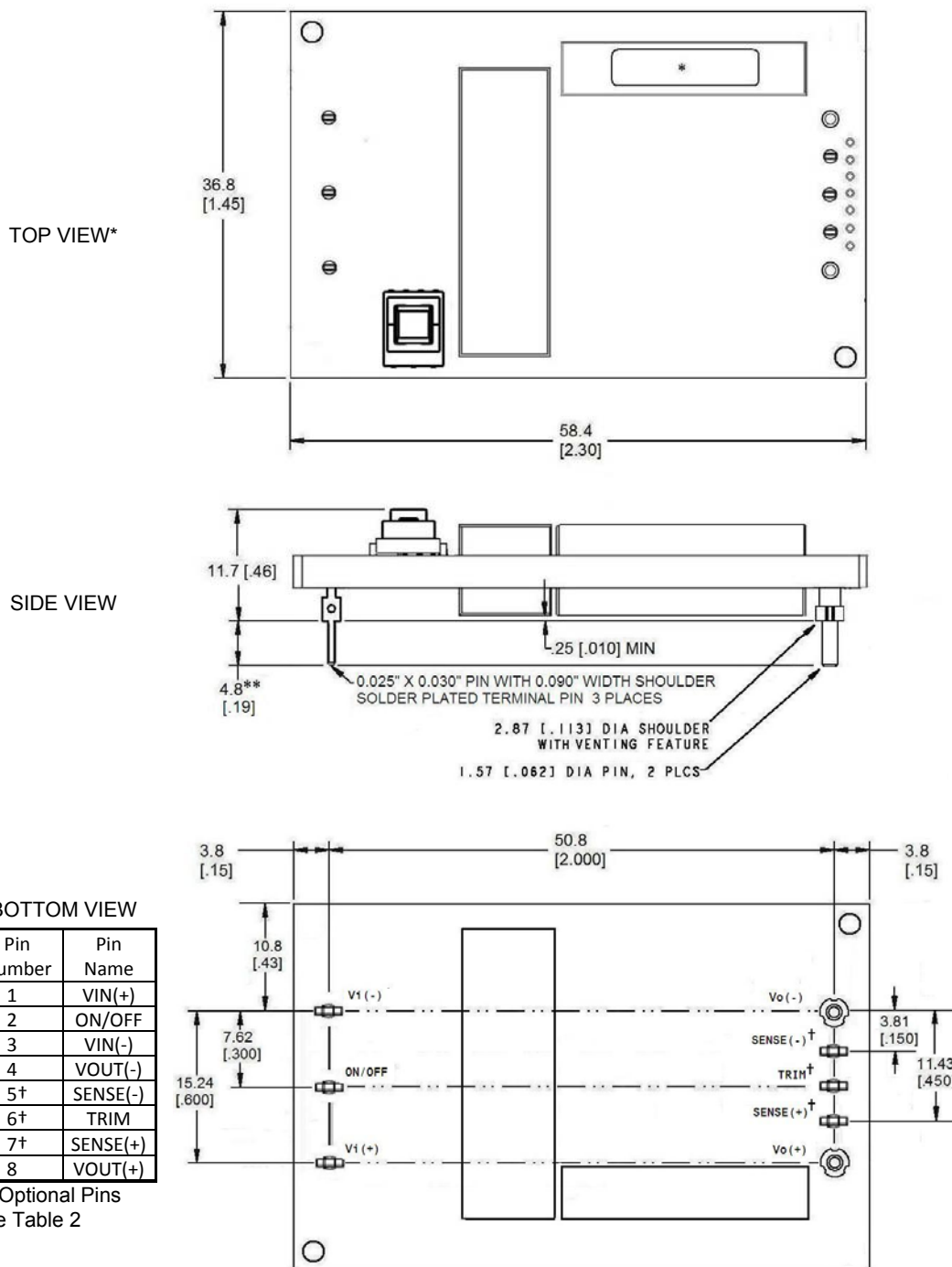
Dimensions are in millimeters and [inches].

Tolerances: x.x mm $\pm$ 0.5 mm [x.xx in. $\pm$ 0.02 in.] (Unless otherwise indicated)

x.xx mm $\pm$ 0.25 mm [x.xxx in. $\pm$ 0.010 in.]

*Top side label includes Lineage Power name, product designation, and data code.

** Standard pin tail length. Optional pin tail lengths shown in Table 2, Device Options.



Mechanical Outline for QBVW025A0B-H (Base plate) Through-hole Module

Dimensions are in millimeters and [inches].

Tolerances: x.x mm $\pm$ 0.5 mm [x.xx in. $\pm$ 0.02 in.] (Unless otherwise indicated)

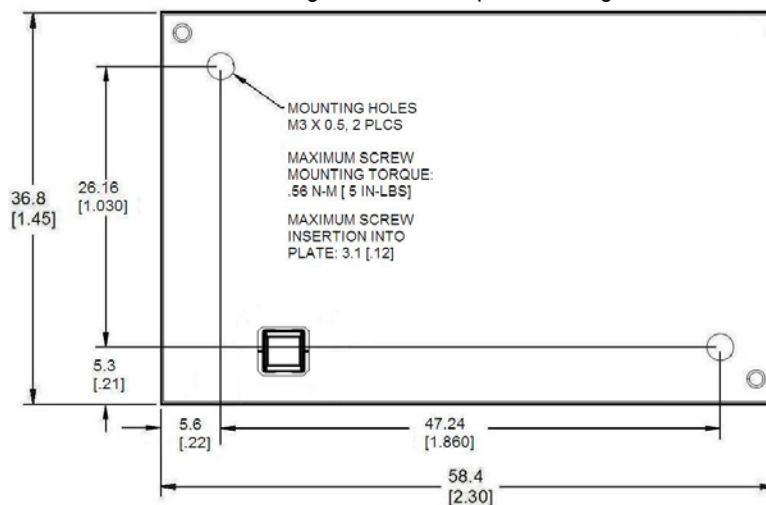
x.xx mm $\pm$ 0.25 mm [x.xxx in. $\pm$ 0.010 in.]

*Side label includes product designation, and data code.

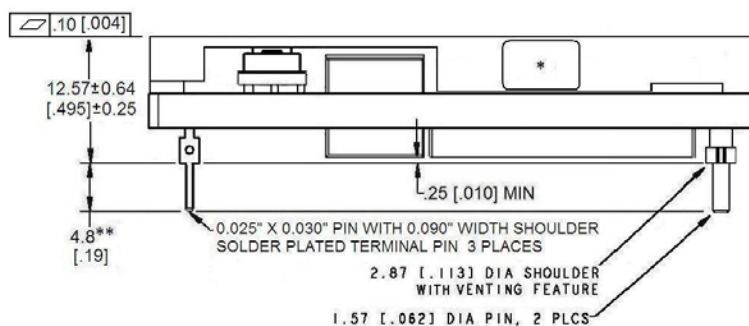
** Standard pin tail length. Optional pin tail lengths shown in Table 2, Device Options.

***Bottom label includes Lineage Power name, product designation, and data code

TOP VIEW



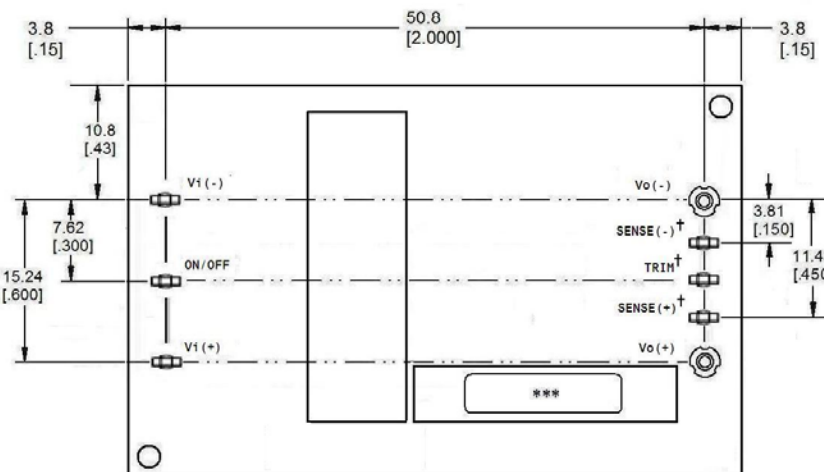
SIDE VIEW*



BOTTOM VIEW***

Pin Number	Pin Name
1	VIN(+)
2	ON/OFF
3	VIN(-)
4	VOUT(-)
5†	SENSE(-)
6†	TRIM†
7†	SENSE(+)
8	VOUT(+)

† - Optional Pins
See Table 2



Recommended Pad Layouts

Dimensions are in millimeters and (inches).

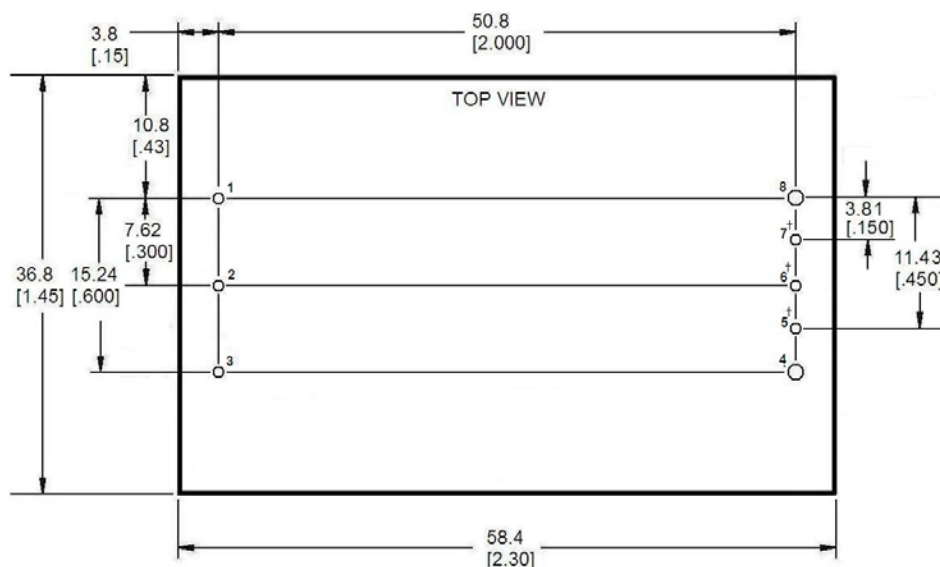
Tolerances: x.x mm $\pm$ 0.5 mm (x.xx in. $\pm$ 0.02 in.) [unless otherwise indicated]

x.xx mm $\pm$ 0.25 mm (x.xxx in $\pm$ 0.010 in.)

Through-Hole Modules

Pin Number	Pin Name
1	VIN(+)
2	ON/OFF
3	VIN(-)
4	VOUT(-)
5†	SENSE(-)
6†	TRIM
7†	SENSE(+)
8	VOUT(+)

† - Optional Pins
See Table 2



Packaging Details

All versions of the QBVW025A0B are supplied as standard in the plastic trays shown in Figure 26.

Tray Specification

Material	PET (1mm)
Max surface resistivity	$10^9 - 10^{11} \Omega/\text{PET}$
Color	Clear
Capacity	12 power modules
Min order quantity	24 pcs (1 box of 2 full trays + 1 empty top tray)

Each tray contains a total of 12 power modules. The trays are self-stacking and each shipping box for the QBVW025A0B module contains 2 full trays plus one empty hold-down tray giving a total number of 24 power modules.



Figure 26. QBVW025 Packaging Tray

Ordering Information

Please contact your Lineage Power Sales Representative for pricing, availability and optional features.

Table 1. Device Codes

Product codes	Input Voltage	Output Voltage	Output Current	Efficiency	Connector Type	Comcodes
QBVW025A0BZ	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109167796
QBVW025A0B1Z	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109167383
QBVW025A0B41Z	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109166195
QBVW025A0B61Z	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109167391
QBVW025A0B64Z	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109169875
QBVW025A0B641Z	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109166204
QBVW025A0B841Z	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109168407
QBVW025A0B964Z	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109173167
QBVW025A0B1-HZ	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109167400
QBVW025A0B41-HZ	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109166798
QBVW025A0B51-HZ	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109167417
QBVW025A0B61-HZ	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109167821
QBVW025A0B641-HZ	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109166815
QBVW025A0B941-HZ	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	150020599
QBVW025A0B-PHZ	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109170065
QBVW025A0B1-PHZ	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109167425
QBVW025A0B41-PHZ	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109167433
QBVW025A0B641-PHZ	48V (36–75V _{dc})	12V	25A	96.0%	Through hole	CC109173092

Table 2. Device Options

	Characteristic	Character and Position	Definition
Ratings	Form Factor	Q	Q = Quarter Brick
	Family Designator	BV	BV = BARRACUDA Series, without PMBus interface
	Input Voltage	W	W = Wide Range, 36V-75V
	Output Current	025A0	025A0 = 025.0 Amps Maximum Output Current
	Output Voltage	B	B = 12.0V nominal
Options	Trim and Remote Sense Pins	9	Omit = Exclude Trim & Sense Pins 9 = Include Trim and Sense Pins
	Pin Length	8	Omit = Default Pin Length shown in Mechanical Outline Figures 8 = Pin Length: 2.79 mm ± 0.25mm , (0.110 in. ± 0.010 in.)
		6	6 = Pin Length: 3.68 mm ± 0.25mm , (0.145 in. ± 0.010 in.)
		5	5 = Pin Length: 6.35 mm ± 0.25mm , (0.250 in. ± 0.010 in.)
	Action following Protective Shutdown	4	Omit = Latching Mode 4 = Auto-restart following shutdown (Overcurrent/Overvoltage)
	On/Off Logic		Omit = Positive Logic
		1	1 = Negative Logic
	Customer Specific	XY	XY = Customer Specific Modified Code, Omit for Standard Code
	Optional Features	P	Omit = Standard open Frame Module P = Forced Droop Output for use in parallel applications
		H	H = Heat plate, for use with heat sinks or cold-walls
	RoHS		Omit = RoHS 5/6, Lead Based Solder Used Z = RoHS 6/6 Compliant, Lead free



LINEAGE POWER®

World Wide Headquarters
Lineage Power Corporation
601 Shiloh Road, Plano, TX 75074, USA
+1-888-LINEAGE(546-3243)
(Outside U.S.A.: +1-972-244-WATT(9288))
www.lineagepower.com
e-mail: techsupport1@lineagepower.com

Asia-Pacific Headquarters
Tel: +86.021.54279977*808

Europe, Middle-East and Africa Headquarters
Tel: +49.89.878067-280

India Headquarters
Tel: +91.80.28411633

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Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

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moschip.ru_9